74HC373-Q100; 74HCT373-Q100

Octal D-type transparent latch; 3-state Rev. 1 — 10 August 2012

Product data sheet

General description 1.

The 74HC373-Q100; 74HCT373-Q100 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL. It is specified in compliance with JEDEC standard no. 7A.

The 74HC373-Q100; 74HCT373-Q100 is an octal D-type transparent latch featuring separate D-type inputs for each latch and 3-state outputs for bus-oriented applications. A latch enable (LE) input and an output enable (OE) input are common to all latches.

The 74HC373-Q100; 74HCT373-Q100 consists of eight D-type transparent latches with 3-state true outputs. When LE is HIGH, data at the Dn inputs enters the latches. In this condition the latches are transparent, i.e. a latch output changes state each time its corresponding D input changes.

When LE is LOW, the latches store the information that was present at the D inputs a set-up time preceding the HIGH-to-LOW transition of LE. When OE is LOW, the contents of the 8 latches are available at the outputs. When OE is HIGH, the outputs go to the highimpedance OFF-state. Operation of the OE input does not affect the state of the latches.

The 74HC373-Q100; 74HCT373-Q100 is functionally identical to:

74HC573-Q100; 74HCT573-Q100: but different pin arrangement

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Input levels:
 - For 74HC373-Q100: CMOS level
 - For 74HCT373-Q100: TTL level
- 3-state non-inverting outputs for bus-oriented applications
- Common 3-state output enable input
- Functionally identical to the 74HC573-Q100; 74HCT573-Q100
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

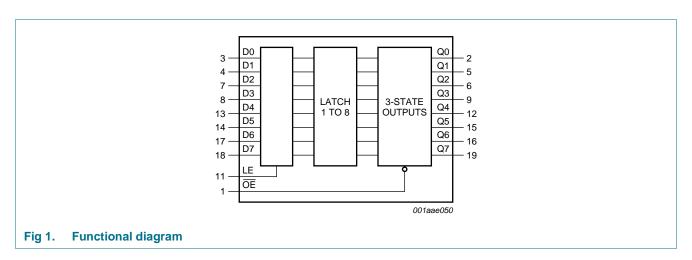


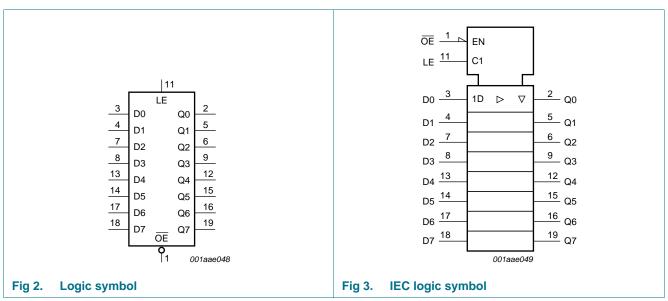
3. Ordering information

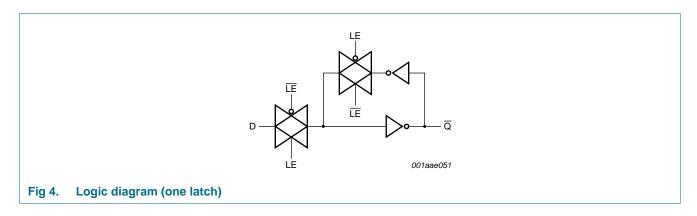
Table 1. Ordering information

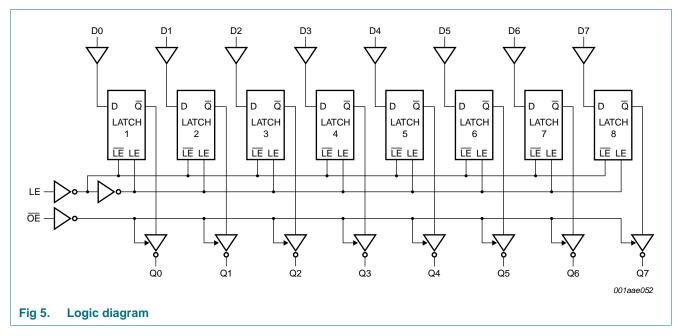
Type number	Package							
	Temperature range	Name	Description	Version				
74HC373D-Q100	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1				
74HCT373D-Q100			body width 7.5 mm					
74HC373PW-Q100	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1				
74HCT373PW-Q100			body width 4.4 mm					
74HC373BQ-Q100	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very	SOT764-1				
74HCT373BQ-Q100	_		thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm					

4. Functional diagram



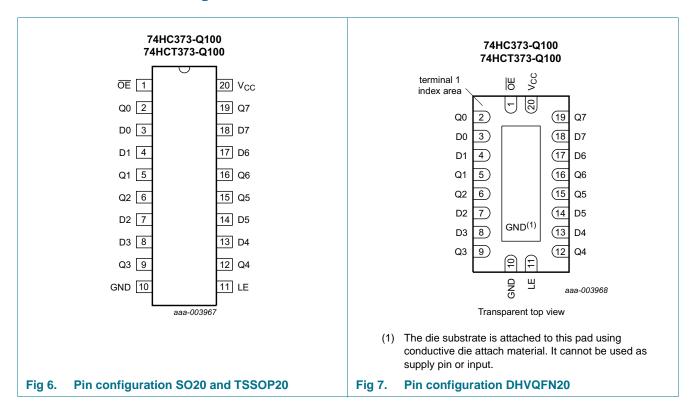






5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
ŌE	1	3-state output enable input (active LOW)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	2, 5, 6, 9, 12, 15, 16, 19	3-state latch output
D0, D1, D2, D3, D4, D5, D6, D7	3, 4, 7, 8, 13, 14, 17, 18	data input
GND	10	ground (0 V)
LE	11	latch enable input (active HIGH)
V _{CC}	20	supply voltage

6. Functional description

6.1 Function table

Table 3. Function table[1]

Operating mode	Control		Input	Internal latches	Output
	OE LE I		Dn	_	Qn
Enable and read register	L	Н	L	L	L
(transparent mode)			Н	Н	Н
Latch and read register	L	L	I	L	L
			h	Н	Н
Latch register and disable outputs	Н	X	X	Х	Z

^[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-	±35	mA
I _{CC}	supply current		-	+70	mA
I_{GND}	ground current		-	-70	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	SO20 package	<u>[1]</u> -	500	mW
		TSSOP20 package	[2]	500	mW
		DHVQFN20 package	[3] _	500	mW

^[1] For SO20: P_{tot} derates linearly with 8 mW/K above 70 $^{\circ}\text{C}.$

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;

X = don't care;

Z = high-impedance OFF-state.

^[2] For TSSOP20 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

^[3] For DHVQFN20 package: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Conditions 74HC373-Q100		74HCT373-Q100			Unit	
			Min	Тур	Max	Min	Тур	Max	
V_{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 \text{ V}$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 \text{ V}$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 \text{ V}$	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics 74HC373-Q100

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	1.2	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	V
V_{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}	-	-	-	
		$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	V
		$I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	V
		$I_{O} = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	μΑ
I _{CC}	supply current	V_{CC} = 6.0 V; I_{O} = 0 A; V_{I} = V_{CC} or GND	-	-	8.0	μΑ
Cı	input capacitance		-	3.5	-	pF

74HC_HCT373_Q100

 Table 6.
 Static characteristics 74HC373-Q100 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{amb} = -4$	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 \text{ V}$	1.5	-	-	V
		V _{CC} = 4.5 V	3.15	-	-	V
		V _{CC} = 6.0 V	4.2	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 2.0 \text{ V}$	-	-	0.5	V
		V _{CC} = 4.5 V	-	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.8	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	-	-	V
		$I_O = -20 \mu A; V_{CC} = 4.5 V$	4.4	-	-	V
		$I_O = -20 \mu A; V_{CC} = 6.0 V$	5.9	-	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.84	-	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.34	-	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 V$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
		$I_{O} = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.33	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μΑ
l _{oz}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 6.0 \text{ V}$; $V_O = V_{CC}$ or GND	-	-	±5.0	μА
lcc	supply current	$V_{CC} = 6.0 \text{ V}; I_O = 0 \text{ A};$ $V_I = V_{CC} \text{ or GND}$		-	80	μА
T _{amb} = -4	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	-	-	V
		V _{CC} = 4.5 V	3.15	-	-	V
		V _{CC} = 6.0 V	4.2	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	-	0.5	V
		V _{CC} = 4.5 V	-	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	-	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	-	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	-	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.2	-	-	V

Table 6. Static characteristics 74HC373-Q100 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = 20 \mu A; V_{CC} = 2.0 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 V$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.4	V
		$I_{O} = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μΑ
I _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 6.0 \text{ V}$; $V_O = V_{CC}$ or GND	-	-	±10.0	μΑ
I _{CC}	supply current	$V_{CC} = 6.0 \text{ V}; I_O = 0 \text{ A};$ $V_I = V_{CC} \text{ or GND}$	-	-	160	μА

Table 7. Static characteristics 74HCT373-Q100

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					
V_{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	1.2	0.8	V
V_{OH}	HIGH-level output voltage	$V_{I} = V_{IH}$ or V_{IL}				
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	V
V_{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0.0	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.16	0.26	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; $I_O = 0$ A	-	-	±0.5	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	μΑ
ΔI_{CC}	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$				
		Dn	-	30	108	μΑ
		LE	-	150	540	μΑ
		ŌE	-	100	360	μΑ
C _I	input capacitance		-	3.5	-	pF
$T_{amb} = -4$	0 °C to +85 °C					
V_{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	0.8	V

 Table 7.
 Static characteristics 74HCT373-Q100 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	-	-	V
		$I_O = -6.0 \mu A; V_{CC} = 4.5 V$	3.84	-	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μΑ
I _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; $I_O = 0$ A	-	-	±5.0	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	80	μА
Δl _{CC}	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$				
		Dn	-	-	135	μΑ
		LE	-	-	675	μΑ
		ŌĒ	-	-	450	μΑ
$T_{amb} = -4$	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	8.0	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = -20 \mu A; V_{CC} = 4.5 V$	4.4	-	-	V
		$I_O = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; $I_O = 0$ A	-	-	±10	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	160	μА
ΔI _{CC}	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$				
		Dn	-	-	147	μΑ
		LE	-	-	735	μΑ
		ŌĒ	-	-	490	μΑ

10. Dynamic characteristics

Table 8. Dynamic characteristics 74HC373-Q100

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see <u>Figure 12</u>.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{amb} = 2$	25 °C					
t _{pd}	propagation delay	Dn to Qn; see Figure 8	[1]			
		V _{CC} = 2.0 V	-	41	150	ns
		V _{CC} = 4.5 V	-	15	30	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$	-	12	-	ns
		V _{CC} = 6.0 V	-	12	26	ns
		LE to Qn; see Figure 9				
		V _{CC} = 2.0 V	-	50	175	ns
		V _{CC} = 4.5 V	-	18	35	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$	-	15	-	ns
		V _{CC} = 6.0 V	-	14	30	ns
t _{en}	enable time	OE to Qn; see Figure 10	<u>[2]</u>			
		V _{CC} = 2.0 V	-	44	150	ns
		V _{CC} = 4.5 V	-	16	30	ns
		V _{CC} = 6.0 V	-	13	26	ns
t _{dis}	disable time	OE to Qn; see Figure 10	<u>[3]</u>			
		V _{CC} = 2.0 V	-	47	150	ns
		V _{CC} = 4.5 V	-	17	30	ns
		V _{CC} = 6.0 V	-	14	26	ns
t _t	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>			
		$V_{CC} = 2.0 \text{ V}$	-	14	60	ns
		V _{CC} = 4.5 V	-	5	12	ns
		V _{CC} = 6.0 V	-	4	10	ns
t _W	pulse width	LE HIGH; see Figure 9				
		V _{CC} = 2.0 V	80	17	-	ns
		V _{CC} = 4.5 V	16	6	-	ns
		V _{CC} = 6.0 V	14	5	-	ns
t _{su}	set-up time	Dn to LE; see Figure 11				
		V _{CC} = 2.0 V	50	14	-	ns
		V _{CC} = 4.5 V	10	5	-	ns
		V _{CC} = 6.0 V	9	4	-	ns
t _h	hold time	Dn to LE; see Figure 11				
		V _{CC} = 2.0 V	+5	-8	-	ns
		V _{CC} = 4.5 V	+5	-3	-	ns
		V _{CC} = 6.0 V	+5	-2	-	ns
C_{PD}	power dissipation capacitance	per latch; $V_I = GND$ to V_{CC}	<u>[5]</u> _	45	-	pF

Table 8. Dynamic characteristics 74HC373-Q100 ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	T _{amb} = -	40 °C to +85 °C					
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	t _{pd}	propagation delay	Dn to Qn; see Figure 8	[1]			
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			V _{CC} = 2.0 V	-	-	190	ns
$ \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$			V _{CC} = 4.5 V	-	-	38	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			V _{CC} = 6.0 V	-	-	33	ns
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			LE to Qn; see Figure 9				
			V _{CC} = 2.0 V	-	-	220	ns
$ \begin{array}{c} \text{en} \\ \text{ne} $			V _{CC} = 4.5 V	-	-	44	ns
$\begin{array}{c} V_{CC} = 2.0 \ V & - & - & 190 & ns \\ V_{CC} = 4.5 \ V & - & - & 38 & ns \\ V_{CC} = 6.0 \ V & - & - & 33 & ns \\ \hline V_{CC} = 6.0 \ V & - & - & 33 & ns \\ \hline V_{CC} = 2.0 \ V & - & - & 190 & ns \\ \hline V_{CC} = 2.0 \ V & - & - & 190 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 38 & ns \\ \hline V_{CC} = 6.0 \ V & - & - & 38 & ns \\ \hline V_{CC} = 6.0 \ V & - & - & 33 & ns \\ \hline V_{CC} = 6.0 \ V & - & - & 75 & ns \\ \hline V_{CC} = 2.0 \ V & - & - & 75 & ns \\ \hline V_{CC} = 2.0 \ V & - & - & 75 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 15 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 15 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 13 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 13 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 15 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 15 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 15 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & - & ns \\ \hline V_{CC} = 4.5 \ V & - & - & - & ns \\ \hline V_{CC} = 4.5 \ V & - & - & - & ns \\ \hline V_{CC} = 4.5 \ V & - & - & - & ns \\ \hline V_{CC} = 4.5 \ V & - & - $			V _{CC} = 6.0 V	-	-	37	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{en}	enable time	OE to Qn; see Figure 10	[2]			
			V _{CC} = 2.0 V	-	-	190	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			V _{CC} = 4.5 V	-	-	38	ns
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			V _{CC} = 6.0 V	-	-	33	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{dis}	disable time	OE to Qn; see Figure 10	<u>[3]</u>			
$ \begin{array}{c} V_{CC} = 6.0 \ V & - & - & 33 & ns \\ \hline transition time & Qn; see Figure 8 and Figure 9 & 4 & & & \\ \hline V_{CC} = 2.0 \ V & - & - & 75 & ns \\ \hline V_{CC} = 4.5 \ V & - & - & 15 & ns \\ \hline V_{CC} = 6.0 \ V & - & - & 13 & ns \\ \hline V_{CC} = 6.0 \ V & - & - & 13 & ns \\ \hline V_{CC} = 2.0 \ V & 100 & - & - & ns \\ \hline V_{CC} = 2.0 \ V & 100 & - & - & ns \\ \hline V_{CC} = 4.5 \ V & 20 & - & - & ns \\ \hline V_{CC} = 6.0 \ V & 17 & - & - & ns \\ \hline V_{CC} = 6.0 \ V & 17 & - & - & ns \\ \hline V_{CC} = 6.0 \ V & 17 & - & - & ns \\ \hline V_{CC} = 4.5 \ V & 20 & - & - & ns \\ \hline V_{CC} = 6.0 \ V & 17 & - & - & ns \\ \hline V_{CC} = 4.5 \ V & 13 & - & - & ns \\ \hline V_{CC} = 4.5 \ V & 13 & - & - & ns \\ \hline V_{CC} = 6.0 \ V & 11 & - & - & ns \\ \hline V_{CC} = 2.0 \ V & 5 & - & - & ns \\ \hline V_{CC} = 2.0 \ V & 5 & - & - & ns \\ \hline V_{CC} = 2.0 \ V & 5 & - & - & ns \\ \hline V_{CC} = 4.5 \ V & 5 & - & - & - & ns \\ \hline V_{CC} = 4.5 \ V & 5 & - & - & - & ns \\ \hline V_{CC} = 4.5 \ V & 5 & - & - & - & - & - & - \\ \hline V_{CC} = 4.5 \ V & 5 & - & - & - & - & - & - \\ \hline V_{CC} = 4.5 \ V & 5 & - & - & - & - & - & - \\ \hline V_{CC} = 4.5 \ V $			V _{CC} = 2.0 V	-	-	190	ns
$ \begin{array}{c} t \\ t $			V _{CC} = 4.5 V	-	-	38	ns
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			V _{CC} = 6.0 V	-	-	33	ns
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _t	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>			
$V_{CC} = 6.0 \text{ V} \qquad - \qquad - \qquad 13 \qquad \text{ns}$ $W_{W} \qquad \text{pulse width} \qquad \begin{array}{c ccccccccccccccccccccccccccccccccccc$			V _{CC} = 2.0 V	-	-	75	ns
$\begin{array}{c} \text{Pulse width} \\ \text{Pulse width} \\ & \begin{array}{c} \text{LE HIGH; see Figure 9} \\ \hline V_{CC} = 2.0 \ \text{V} \\ \hline V_{CC} = 4.5 \ \text{V} \\ \hline V_{CC} = 6.0 \ \text{V} \\ \hline \end{array} \\ & \begin{array}{c} \text{100} - & \text{ns} \\ \hline V_{CC} = 6.0 \ \text{V} \\ \hline \end{array} \\ \text{17} - & \text{ns} \\ \hline V_{CC} = 6.0 \ \text{V} \\ \hline \end{array} \\ & \begin{array}{c} \text{Dn to LE; see Figure 11} \\ \hline V_{CC} = 2.0 \ \text{V} \\ \hline V_{CC} = 4.5 \ \text{V} \\ \hline \end{array} \\ & \begin{array}{c} \text{13} - & \text{ns} \\ \hline V_{CC} = 6.0 \ \text{V} \\ \hline \end{array} \\ \text{11} - & \text{ns} \\ \hline \end{array} \\ & \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \end{array} \\ & \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \end{array} \\ & \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \end{array} \\ \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \end{array} \\ \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \end{array} \\ \begin{array}{c} \text{Ns} \\ \hline \end{array} \\ \begin{array}{c} \text{Ns} \\ \end{array}$			V _{CC} = 4.5 V	-	-	15	ns
$V_{CC} = 2.0 \text{ V} $			V _{CC} = 6.0 V	-	-	13	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _W	pulse width	LE HIGH; see Figure 9				
$V_{CC} = 6.0 \text{ V} \qquad 17 \text{ ns}$ set-up time $ \frac{\text{Dn to LE; see Figure 11}}{V_{CC} = 2.0 \text{ V}} \qquad 65 \text{ ns} $ $ \frac{V_{CC} = 4.5 \text{ V}}{V_{CC} = 6.0 \text{ V}} \qquad 13 \text{ ns} $ $ \frac{V_{CC} = 6.0 \text{ V}}{V_{CC} = 6.0 \text{ V}} \qquad 11 \text{ ns} $ $ \frac{V_{CC} = 2.0 \text{ V}}{V_{CC} = 2.0 \text{ V}} \qquad 5 \text{ ns} $ $ \frac{V_{CC} = 2.0 \text{ V}}{V_{CC} = 4.5 \text{ V}} \qquad 5 \text{ ns} $			V _{CC} = 2.0 V	100	-	-	ns
			V _{CC} = 4.5 V	20	-	-	ns
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			V _{CC} = 6.0 V	17	-	-	ns
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{su}	set-up time	Dn to LE; see Figure 11				
$V_{CC} = 6.0 \text{ V} & 11 & - & - & \text{ns} \\ & & & \\ \text{hold time} & & \\ \hline & & \\ \text{Dn to LE; see } \frac{\text{Figure 11}}{\text{Eigure 11}} \\ & & \\ \hline & & \\ V_{CC} = 2.0 \text{ V} & 5 & - & - & \text{ns} \\ \hline & & \\ \hline & & \\ V_{CC} = 4.5 \text{ V} & 5 & - & - & \text{ns} \\ \hline \end{array}$			V _{CC} = 2.0 V	65	-	-	ns
h hold time $\frac{\text{Dn to LE; see } \underline{\text{Figure 11}}}{\text{V}_{CC} = 2.0 \text{ V}} \qquad \qquad 5 \qquad - \qquad \text{ns}} \\ \overline{\text{V}_{CC} = 4.5 \text{ V}} \qquad \qquad 5 \qquad - \qquad - \qquad \text{ns}}$			$V_{CC} = 4.5 \text{ V}$	13	-	-	ns
$V_{CC} = 2.0 \text{ V}$ 5 - ns $V_{CC} = 4.5 \text{ V}$ 5 - ns			V _{CC} = 6.0 V	11	-	-	ns
$V_{CC} = 4.5 \text{ V}$ 5 ns	t _h	hold time	Dn to LE; see Figure 11				
			V _{CC} = 2.0 V	5	-	-	ns
$V_{CC} = 6.0 \text{ V}$ 5 ns			V _{CC} = 4.5 V	5	-	-	ns
			V _{CC} = 6.0 V	5	-	-	ns

Table 8. Dynamic characteristics 74HC373-Q100 ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	40 °C to +125 °C					
t _{pd}	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>			
		V _{CC} = 2.0 V	-	-	225	ns
		V _{CC} = 4.5 V	-	-	45	ns
		V _{CC} = 6.0 V	-	-	38	ns
		LE to Qn; see Figure 9				
		V _{CC} = 2.0 V	-	-	265	ns
		V _{CC} = 4.5 V	-	-	53	ns
		V _{CC} = 6.0 V	-	-	45	ns
t _{en}	enable time	OE to Qn; see Figure 10	[2]			
		V _{CC} = 2.0 V	-	-	225	ns
		V _{CC} = 4.5 V	-	-	45	ns
		V _{CC} = 6.0 V	-	-	38	ns
t _{dis}	disable time	OE to Qn; see Figure 10	[3]			
		V _{CC} = 2.0 V	-	-	225	ns
		V _{CC} = 4.5 V	-	-	45	ns
		V _{CC} = 6.0 V	-	-	38	ns
t _t	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>			
		V _{CC} = 2.0 V	-	-	90	ns
		V _{CC} = 4.5 V	-	-	18	ns
		V _{CC} = 6.0 V	-	-	15	ns
t _W	pulse width	LE HIGH; see Figure 9				
		V _{CC} = 2.0 V	120	-	-	ns
		V _{CC} = 4.5 V	24	-	-	ns
		V _{CC} = 6.0 V	20	-	-	ns
t _{su}	set-up time	Dn to LE; see Figure 11				
		V _{CC} = 2.0 V	75	-	-	ns
		V _{CC} = 4.5 V	15	-	-	ns
		V _{CC} = 6.0 V	13	-	-	ns

Table 8. Dynamic characteristics 74HC373-Q100 ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _h	hold time Dn to LE; see Figure 11					
		$V_{CC} = 2.0 \text{ V}$	5	-	-	ns
		V _{CC} = 4.5 V	5	-	-	ns
		V _{CC} = 6.0 V	5	-	-	ns

- [1] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [2] t_{en} is the same as t_{PZH} and t_{PZL} .
- [3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [4] t_t is the same as t_{THL} and t_{TLH} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

fo = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

 Table 9.
 Dynamic characteristics 74HCT373-Q100

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C					
t _{pd}	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>			
		V _{CC} = 4.5 V	-	17	30	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$	-	14	-	ns
		LE to Qn; see Figure 9				
		V _{CC} = 4.5 V	-	16	32	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$	-	13	-	ns
t _{en} enable time	enable time	OE to Qn; see Figure 10	[2]			
		$V_{CC} = 4.5 \text{ V}$	-	19	32	ns
t _{dis} di	disable time	OE to Qn; see Figure 10	[3]			
		$V_{CC} = 4.5 \text{ V}$	-	18	30	ns
t _t	transition time	Qn; see Figure 8 and Figure 9	[4]			
		V _{CC} = 4.5 V	-	5	12	ns
t _W	pulse width	LE HIGH; see Figure 9				
		V _{CC} = 4.5 V	16	4	-	ns
t _{su}	set-up time	Dn to LE; see Figure 11				
		V _{CC} = 4.5 V	12	6	-	ns
t _h	hold time	Dn to LE; see Figure 11				
		V _{CC} = 4.5 V	4	-1	-	ns
C_{PD}	power dissipation capacitance	per latch; $V_I = GND$ to $(V_{CC} - 1.5 V)$	<u>[5]</u> _	41	-	pF

Table 9. Dynamic characteristics 74HCT373-Q100 ...continued

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	-40 °C to +85 °C					
t _{pd}	propagation delay	Dn to Qn; see Figure 8	[1]			
		V _{CC} = 4.5 V	-	-	38	ns
		LE to Qn; see Figure 9				
		V _{CC} = 4.5 V	-	-	40	ns
t _{en}	enable time	OE to Qn; see Figure 10	[2]			
		V _{CC} = 4.5 V	-	-	40	ns
t _{dis} disable time	disable time	OE to Qn; see Figure 10	[3]			
		V _{CC} = 4.5 V	-	-	38	ns
t _t transition time	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>			
		V _{CC} = 4.5 V	-	-	15	ns
t _W pulse width	pulse width	LE HIGH; see Figure 9				
		V _{CC} = 4.5 V	20	-	-	ns
t _{su} set-up time	set-up time	Dn to LE; see Figure 11				
	V _{CC} = 4.5 V	15	-	-	ns	
t _h hol	hold time	Dn to LE; see Figure 11				
		V _{CC} = 4.5 V	4	-	-	ns
T _{amb} = -	-40 °C to +125 °C					
t _{pd}	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>			
		V _{CC} = 4.5 V	-	-	45	ns
		LE to Qn; see Figure 9				
		V _{CC} = 4.5 V	-	-	48	ns
t _{en}	enable time	OE to Qn; see Figure 10	[2]			
		V _{CC} = 4.5 V	-	-	48	ns
t _{dis}	disable time	OE to Qn; see Figure 10	[3]			
-		V _{CC} = 4.5 V	-	-	45	ns
t _t	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>			
		V _{CC} = 4.5 V	-	-	18	ns
t _W	pulse width	LE HIGH; see Figure 9				
•		V _{CC} = 4.5 V	24	-	-	ns
t _{su}	set-up time Dn to LE	Dn to LE; see Figure 11				
	•	V _{CC} = 4.5 V	18			

Table 9. Dynamic characteristics 74HCT373-Q100 ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _h	hold time Dn to LE	Dn to LE; see Figure 11				
		V _{CC} = 4.5 V	4	-	-	ns

- [1] t_{pd} is the same as t_{PLH} and t_{PHL}.
- [2] t_{en} is the same as t_{PZH} and t_{PZL}.
- [3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [4] t_t is the same as t_{THL} and t_{TLH} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

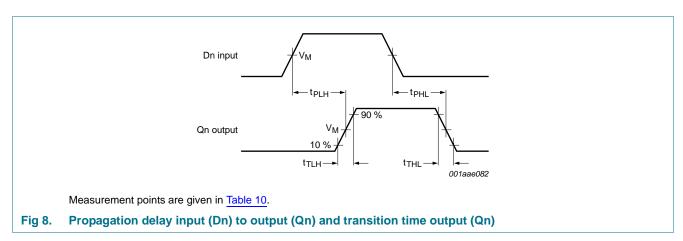
C_I = output load capacitance in pF;

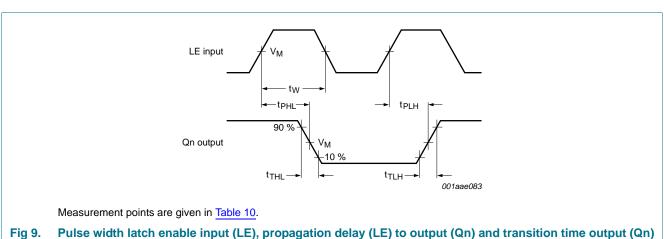
V_{CC} = supply voltage in V;

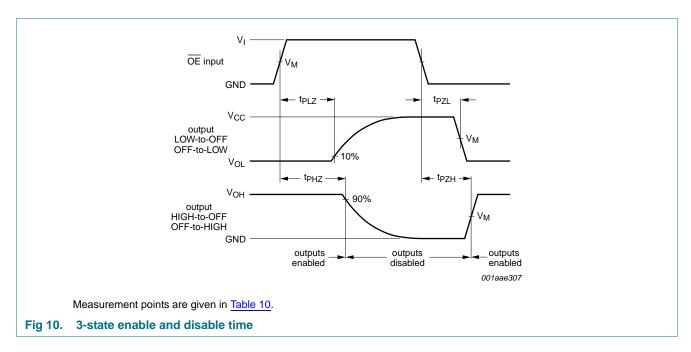
N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

11. Waveforms







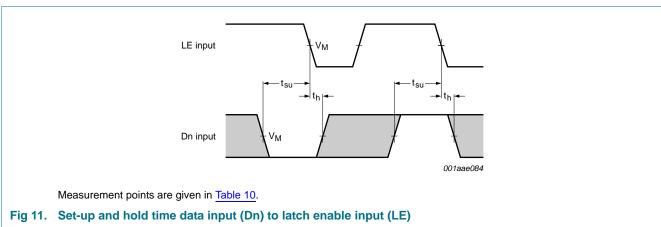
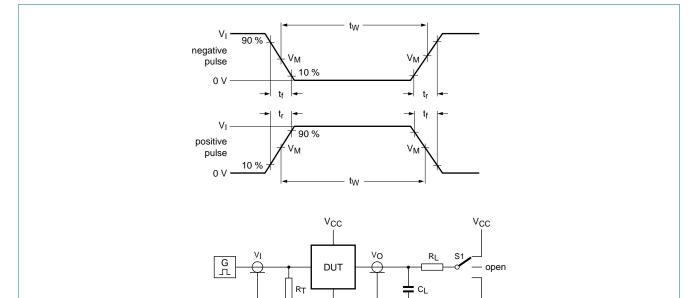


Table 10. Measurement points

Туре	Input	Output
	V _M	V _M
74HC373-Q100	0.5V _{CC}	0.5V _{CC}
74HCT373-Q100	1.3 V	1.3 V

001aad983

Octal D-type transparent latch; 3-state



Test data is given in Table 11.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator

 C_L = Load capacitance including jig and probe capacitance

R_I = Load resistor

S1 = Test selection switch

Fig 12. Test circuit for measuring switching times

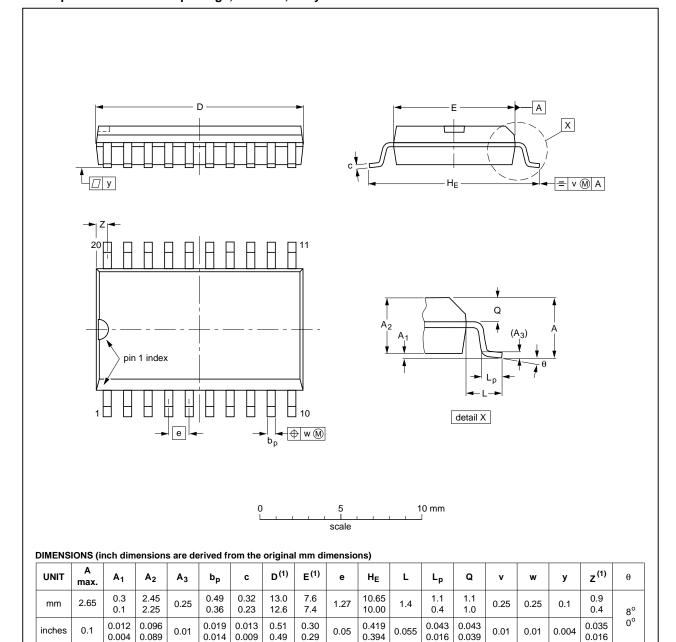
Table 11. Test data

Туре	Input		Load		S1 position		
	VI	t _r , t _f	CL	R _L	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74HC373-Q100	V_{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V_{CC}
74HCT373-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	S EUROPEAN				
VERSION	IEC	JEDEC JEITA			PROJECTION	ISSUE DATE		
SOT163-1	075E04	MS-013				-99-12-27 03-02-19		

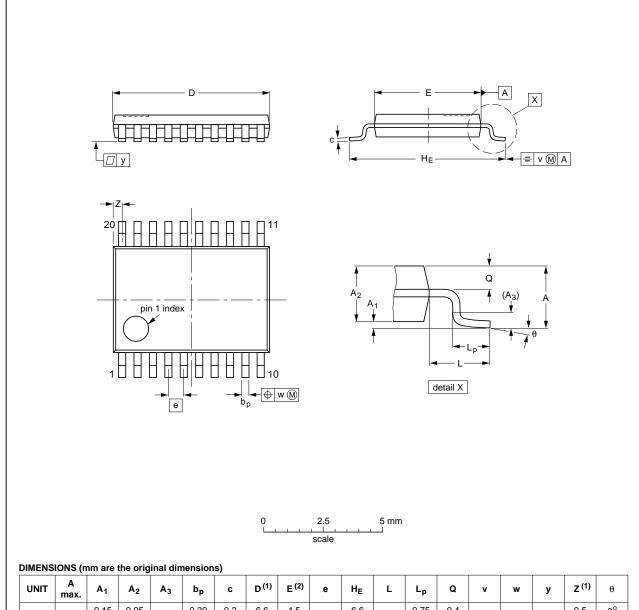
Fig 13. Package outline SOT163-1 (SO20)

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	e	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT360-1		MO-153				99-12-27 03-02-19	
301300-1		WO-153					

Fig 14. Package outline SOT360-1 (TSSOP20)

74HC_HCT373_Q100

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

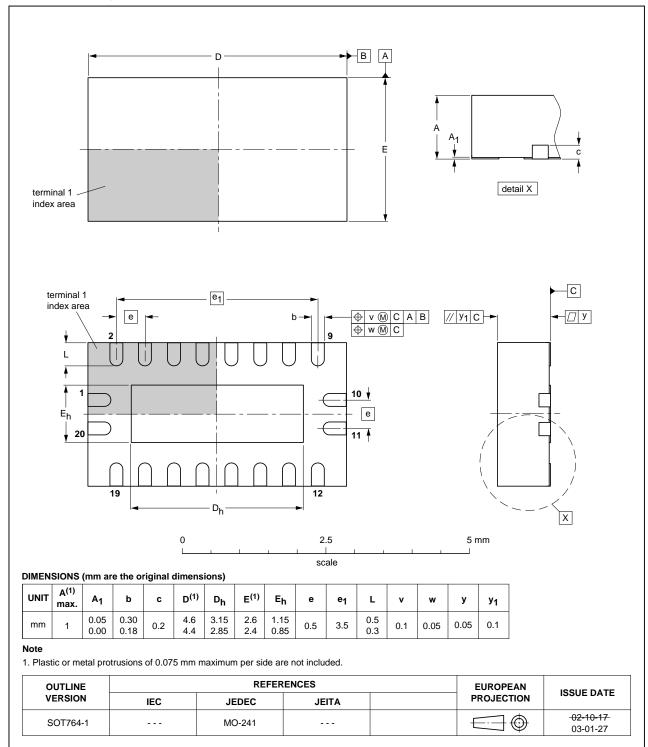


Fig 15. Package outline SOT764-1 (DHVQFN20)

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13. Abbreviations

Table 12. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic
MIL	Military

14. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT373_Q100 v.1	20120810	Product data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Octal D-type transparent latch; 3-state

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